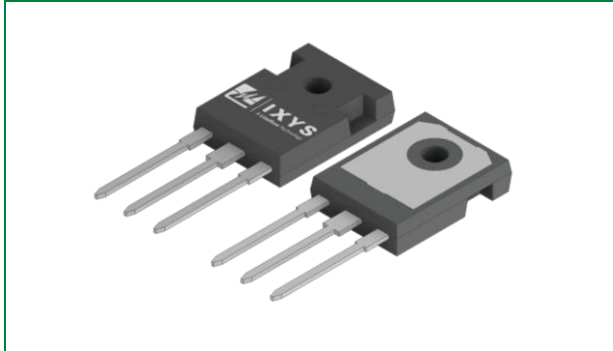


## LSIC1MO120E0120 1200 V, 120 mOhm N-Channel SiC MOSFET

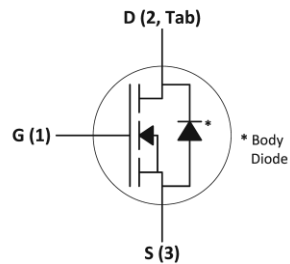
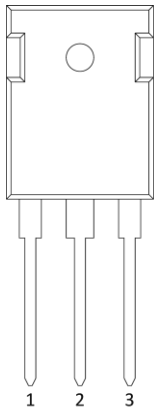


### Agency Approvals and Environmental

Environmental Approvals



### Circuit Diagram



### Product Summary

| Characteristic                                 | Value | Unit |
|--|-------|------|
| $V_{DS}$                                       | 1200  | V    |
| Typical $R_{DS(ON)}$                           | 120   | mOhm |
| $I_D$ ( $T_C \leq 100\text{ }^\circ\text{C}$ ) | 18    | A    |

### Features

- Optimized for high-frequency, high-efficiency applications
- Extremely low gate charge and output capacitance
- Low gate resistance for high-frequency switching
- Normally-off operations at all temperatures
- Ultra-low on-resistance
- RoHS-compliant, lead-free, and halogen-free

### Applications

- High-frequency applications
- Solar Inverters
- Switch Mode Power Supplies
- UPS
- Motor Drives
- High Voltage DC/DC Converters
- Battery Chargers
- Induction Heating

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## 1. Maximum Ratings

| Characteristic                    | Symbol                      | Conditions  | Value       | Unit             |
|-----------------------------------|-----------------------------|---|-------------|------------------|
| Drain-Source Voltage              | $V_{DS}$                    | $V_{GS} = 0\text{ V}$   | 1200        | V                |
| Continuous Drain Current          | $I_D$                       | $V_{GS} = 20\text{ V}, T_C = 25\text{ }^\circ\text{C}$            | 27          | A                |
|                                   |                             | $V_{GS} = 20\text{ V}, T_C = 100\text{ }^\circ\text{C}$           | 18          |                  |
| Pulsed Drain Current <sup>1</sup> | $I_{D(pulse)}$              | $T_C = 25\text{ }^\circ\text{C}$                                  | 60          | A                |
| Power Dissipation                 | $P_D$                       | $T_C = 25\text{ }^\circ\text{C}, T_J = 175\text{ }^\circ\text{C}$ | 156         | W                |
| Gate-Source Voltage               | $V_{GS,MAX}$                | Absolute maximum values – Steady state                            | -6 to +22   | V                |
|                                   | $V_{GS,OP,TR}$ <sup>2</sup> | Transient, $t_{transient} < 300\text{ nsec}$                      | -10 to +25  |                  |
|                                   | $V_{GS,OP}$ <sup>3</sup>    | Recommended DC operating values                                   | -5 to +20   |                  |
| Operating Junction Temperature    | $T_J$                       | -   | -55 to +175 | $^\circ\text{C}$ |
| Storage Temperature               | $T_{STG}$                   | -   | -55 to +150 | $^\circ\text{C}$ |
| Lead Temperature for Soldering    | $T_{sold}$                  | -   | 260         | $^\circ\text{C}$ |
| Mounting Torque                   | $M_D$                       | M3 or 6-32 screw  | 1.0         | Nm               |
|                                   |                             |   | 8.8         | in-lb            |

Footnote 1: Pulse width limited by  $T_{J,MAX}$

Footnote 2: See Figure 21 for further information

Footnote 3: MOSFET can operate with  $V_{GS(OFF)} = 0\text{ V}$ .  $V_{GS(OFF)} = -5\text{ V}$  provides added noise margin and faster turn-off speed

## 2. Thermal Characteristics

| Characteristic                                  | Symbol          | Value | Unit               |
|---|-----------------|-------|--------------------|
| Maximum Thermal Resistance, junction-to-case    | $R_{th,JC,MAX}$ | 0.96  | $^\circ\text{C/W}$ |
| Maximum Thermal Resistance, junction-to-ambient | $R_{th,JA,MAX}$ | 40    | $^\circ\text{C/W}$ |

## 3. Electrical Characteristics

### 3.1. Static Characteristics ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)

| Characteristic                   | Symbol        | Conditions   | Value |     |     | Unit          |
|----------------------------------|---------------|--|-------|-----|-----|---------------|
|                                  |               |  | Min   | Typ | Max |               |
| Drain-Source Breakdown Voltage   | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$                            | 1200  | -   | -   | V             |
| Zero Gate Voltage Drain Current  | $I_{DSS}$     | $V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$                                  | -     | <1  | 100 | $\mu\text{A}$ |
|                                  |               | $V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}, T_J = 175\text{ }^\circ\text{C}$ | -     | <1  | -   |               |
| Gate Leakage Current             | $I_{GSS,F}$   | $V_{GS} = 22\text{ V}, V_{DS} = 0\text{ V}$                                    | -     | -   | 100 | nA            |
|                                  | $I_{GSS,R}$   | $V_{GS} = -6\text{ V}, V_{DS} = 0\text{ V}$                                    | -     | -   | 100 |               |
| Drain-Source On-State Resistance | $R_{DS(ON)}$  | $I_D = 14\text{ A}, V_{GS} = 20\text{ V}$                                      | -     | 120 | 150 | m $\Omega$    |
|                                  |               | $I_D = 14\text{ A}, V_{GS} = 20\text{ V}, T_J = 175\text{ }^\circ\text{C}$     | -     | 170 | -   |               |
| Gate Threshold Voltage           | $V_{GS(TH)}$  | $V_{DS} = V_{GS}, I_D = 7\text{ mA}$   | 1.8   | 2.8 | 4.0 | V             |
|                                  |               | $V_{DS} = V_{GS}, I_D = 7\text{ mA}, T_J = 175\text{ }^\circ\text{C}$          | -     | 1.8 | -   |               |
| Gate Resistance                  | $R_G$         | Resonance method, Drain-Source shorted <sup>1</sup>                            | -     | 0.8 | -   | $\Omega$      |

Footnote 1: For a description of the resonance method for measuring  $R_G$ , refer to the JEDEC Standard JESD24-11 test method

### 3.2. Dynamic Characteristics (T<sub>J</sub> = 25 °C unless otherwise specified)

| Characteristic                   | Symbol              | Conditions   | Value |      |     | Unit |
|----------------------------------|---------------------|--|-------|------|-----|------|
|                                  |                     |  | Min   | Typ  | Max |      |
| Turn-On Switching Energy         | E <sub>ON</sub>     | V <sub>DD</sub> = 800 V, I <sub>D</sub> = 14 A,<br>V <sub>GS</sub> = -5 / +20 V,<br>R <sub>G,ext</sub> = 2 Ω, L = 1.4 mH,<br>FWD = LSIC2SD120A10                           | -     | 160  | -   | μJ   |
| Turn-Off Switching Energy        | E <sub>OFF</sub>    |  | -     | 27   | -   |      |
| Total Per-Cycle Switching Energy | E <sub>TS</sub>     |  | -     | 190  | -   |      |
| Input Capacitance                | C <sub>ISS</sub>    | V <sub>DD</sub> = 800 V, V <sub>GS</sub> = 0 V,<br>f = 1 MHz, V <sub>AC</sub> = 25 mV  | -     | 1130 | -   | pF   |
| Output Capacitance               | C <sub>OSS</sub>    |  | -     | 58   | -   |      |
| Reverse Transfer Capacitance     | C <sub>RSS</sub>    |  | -     | 7    | -   |      |
| COSS Stored Energy               | E <sub>OSS</sub>    |  | -     | 19   | -   |      |
| Total Gate Charge                | Q <sub>g</sub>      | V <sub>DD</sub> = 800 V, I <sub>D</sub> = 14 A,<br>V <sub>GS</sub> = -5 / +20 V  | -     | 63   | -   | nC   |
| Gate-Source Charge               | Q <sub>gs</sub>     |  | -     | 21   | -   |      |
| Gate-Drain Charge                | Q <sub>gd</sub>     |  | -     | 23   | -   |      |
| Turn-On Delay Time               | t <sub>d(on)</sub>  | V <sub>DD</sub> = 800 V, I <sub>D</sub> = 14 A,<br>V <sub>GS</sub> = -5 / +20 V,<br>R <sub>G,ext</sub> = 2 Ω, R <sub>L</sub> = 56 Ω,<br>Timing relative to V <sub>DS</sub> | -     | 12   | -   | ns   |
| Rise Time                        | t <sub>r</sub>      |  | -     | 8    | -   |      |
| Turn-Off Delay Time              | t <sub>d(off)</sub> |  | -     | 16   | -   |      |
| Fall Time                        | t <sub>f</sub>      |  | -     | 8    | -   |      |

### 4. Reverse Diode Characteristics (T<sub>J</sub> = 25 °C unless otherwise specified)

| Characteristic                          | Symbol           | Conditions  | Value |     |     | Unit |
|---|------------------|---|-------|-----|-----|------|
|   |                  |   | Min   | Typ | Max |      |
| Diode Forward Voltage                   | V <sub>SD</sub>  | I <sub>S</sub> = 7 A, V <sub>GS</sub> = -5 V  | -     | 4.2 | -   | V    |
|   |                  | I <sub>S</sub> = 7 A, V <sub>GS</sub> = -5 V, T <sub>J</sub> = 175 °C                         | -     | 3.7 | -   |      |
| Continuous Diode Forward Current        | I <sub>S</sub>   | V <sub>GS</sub> = -5 V, T <sub>C</sub> = 25 °C  | -     | -   | 26  | A    |
| Peak Diode Forward Current <sup>1</sup> | I <sub>SP</sub>  |   | -     | -   | 60  |      |
| Reverse Recovery Time                   | t <sub>rr</sub>  | V <sub>GS</sub> = -5 V, I <sub>S</sub> = 14 A,<br>V <sub>R</sub> = 800 V,<br>di/dt = 5.8 A/ns | -     | 16  | -   | ns   |
| Reverse Recovery Charge                 | Q <sub>rr</sub>  |   | -     | 111 | -   | nC   |
| Peak Reverse Recovery Current           | I <sub>rrm</sub> |   | -     | 17  | -   | A    |

Footnote 1: Pulse width limited by T<sub>J,MAX</sub>

5. Performance Curves

Figure 1. Maximum Power Dissipation ( $T_J = 175\text{ }^\circ\text{C}$ )

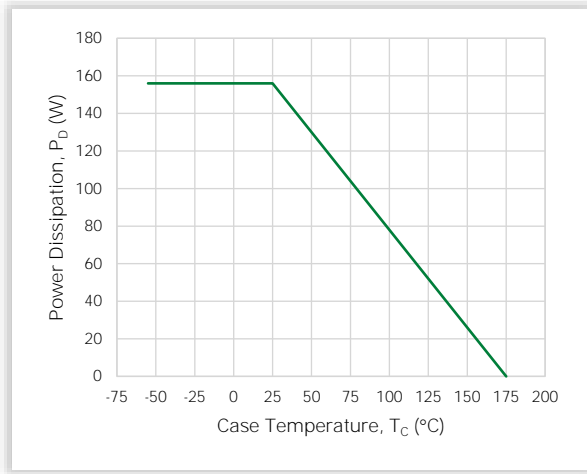


Figure 2. Typical Transfer Characteristics

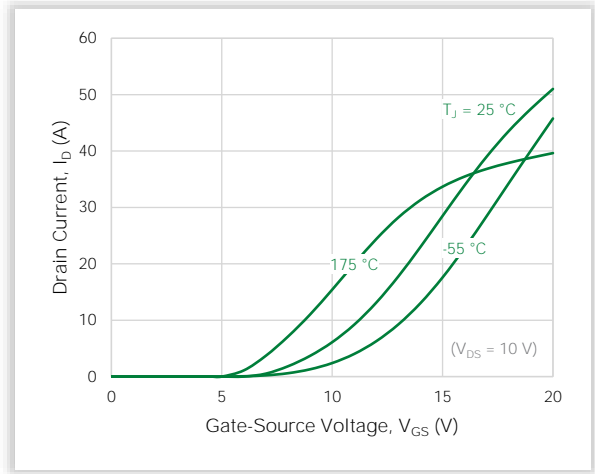


Figure 3. Typical Output Characteristics ( $T_J = 25\text{ }^\circ\text{C}$ )

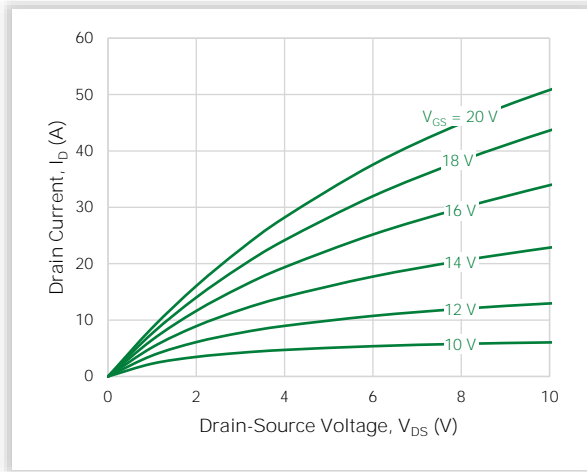


Figure 4. Typical Output Characteristics ( $T_J = 175\text{ }^\circ\text{C}$ )

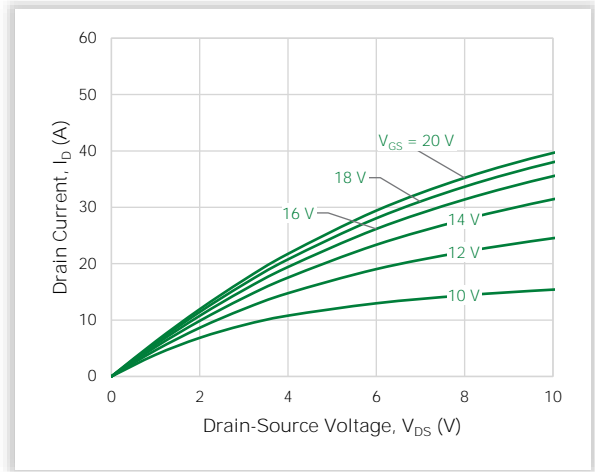


Figure 5. Typical Output Characteristics ( $T_J = -55\text{ }^\circ\text{C}$ )

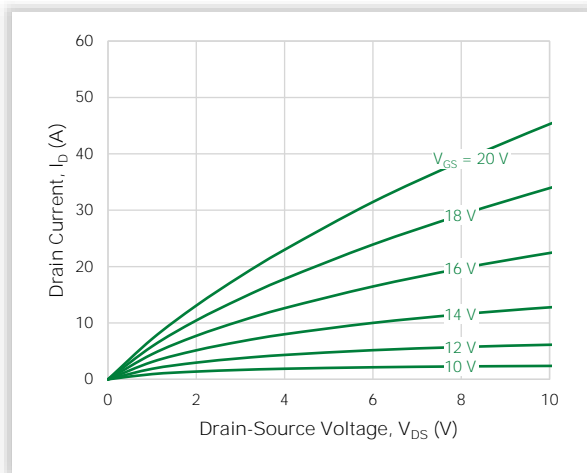


Figure 6. Typical Reverse Conduction Characteristics ( $T_J = 25\text{ }^\circ\text{C}$ )

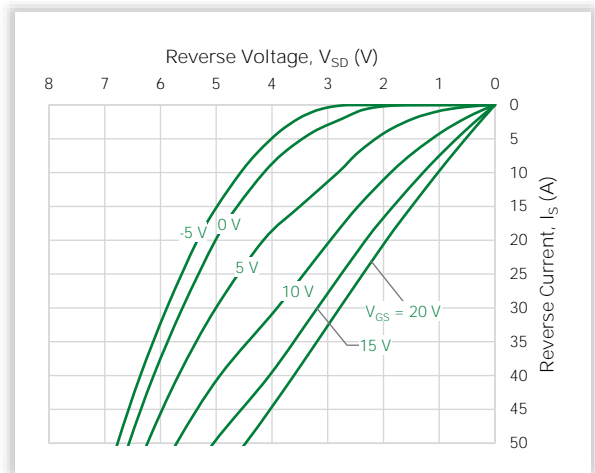


Figure 7. Typical Reverse Conduction Characteristics ( $T_J = 175\text{ }^\circ\text{C}$ )

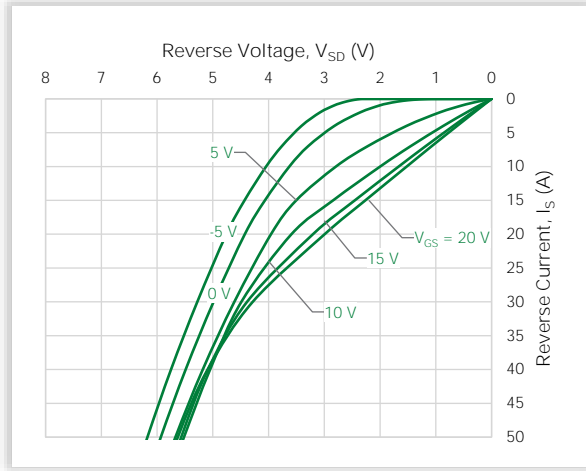


Figure 8. Typical Reverse Conduction Characteristics ( $T_J = -55\text{ }^\circ\text{C}$ )

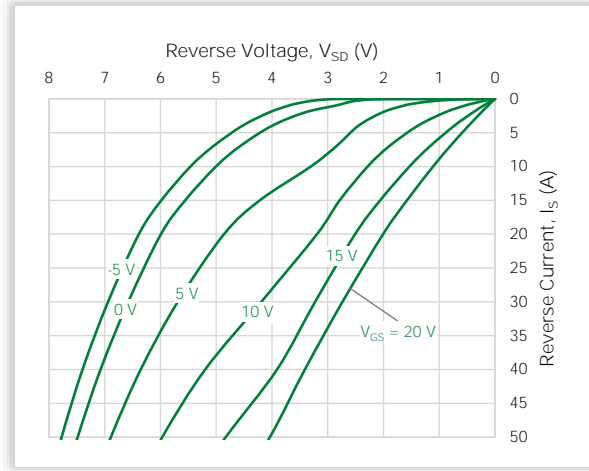


Figure 9. Transient Thermal Impedance

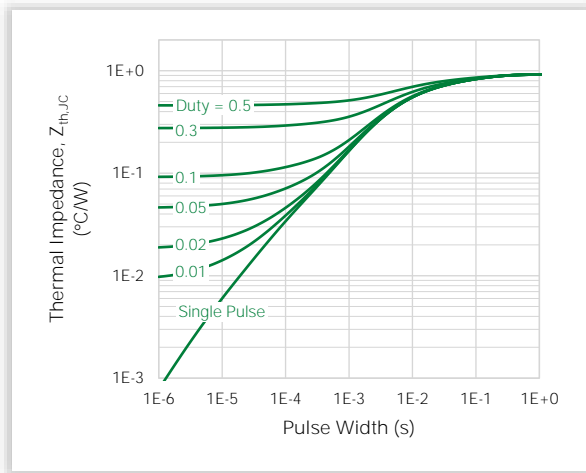


Figure 10. Maximum Safe Operating Area ( $T_C = 25\text{ }^\circ\text{C}$ )

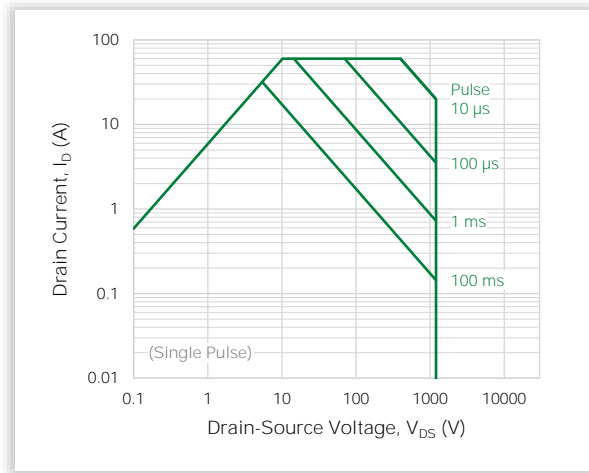


Figure 11. On-resistance vs. Drain Current

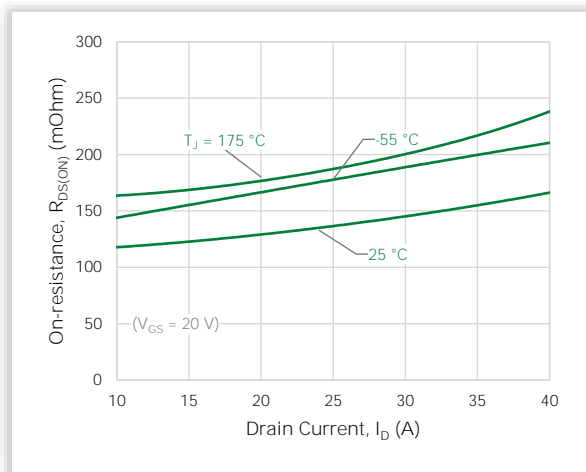


Figure 12. Normalized On-resistance vs. Junction Temperature

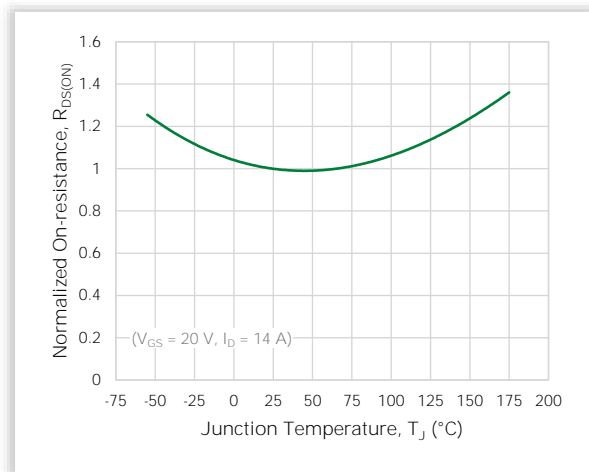


Figure 13. Typical On-resistance vs. Junction Temperature

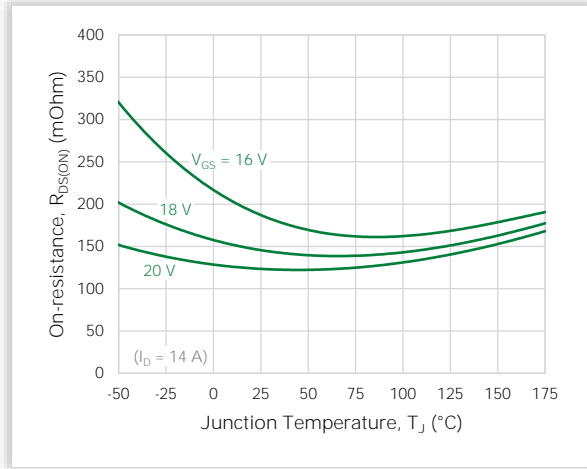


Figure 14. Typical Threshold Voltage

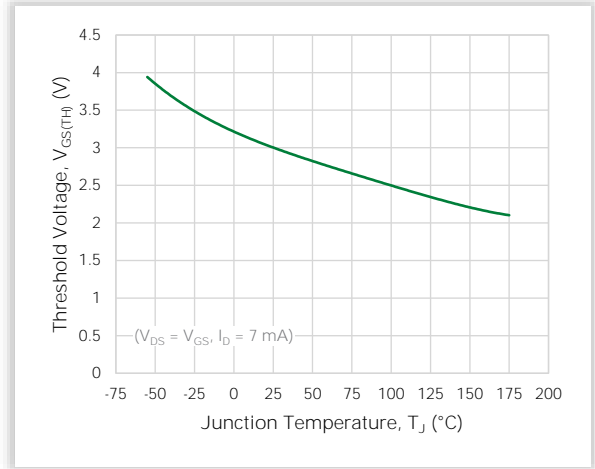


Figure 15. Typical Junction Capacitances up to 1000 V

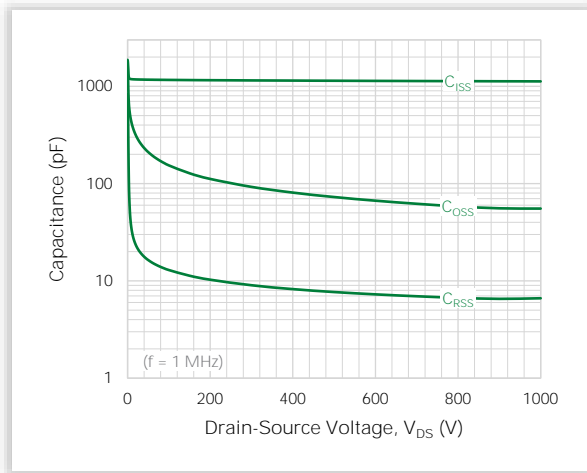


Figure 16. Typical Junction Capacitances up to 200 V

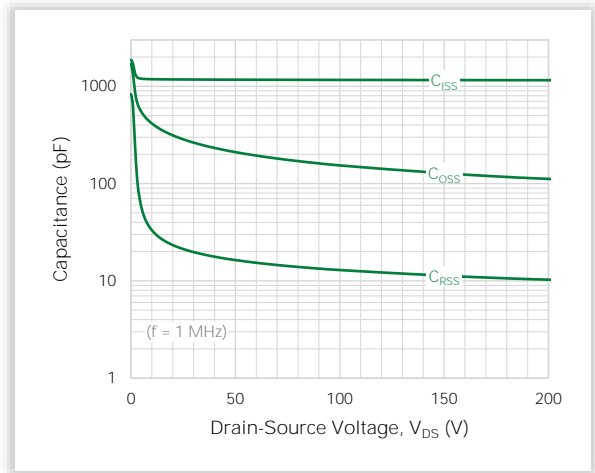


Figure 17. Typical  $C_{oss}$  Stored Energy  $E_{oss}$

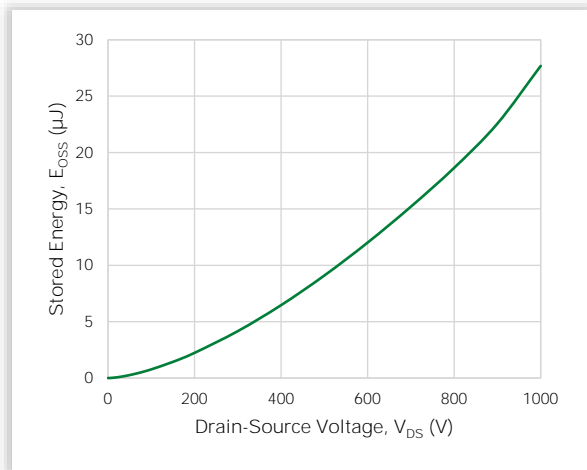


Figure 18. Typical Gate Charge

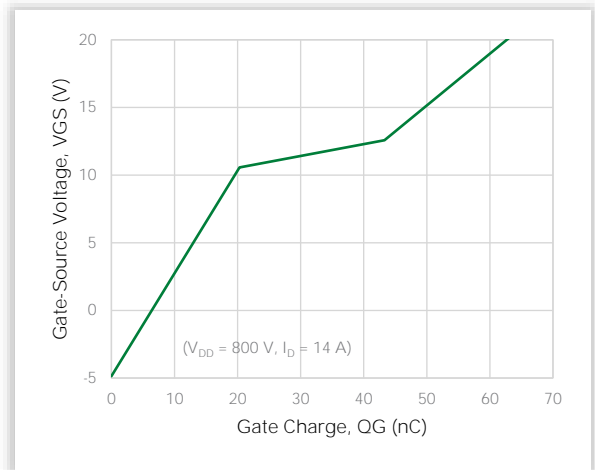


Figure 19. Typical Switching Energy vs. Drain Current

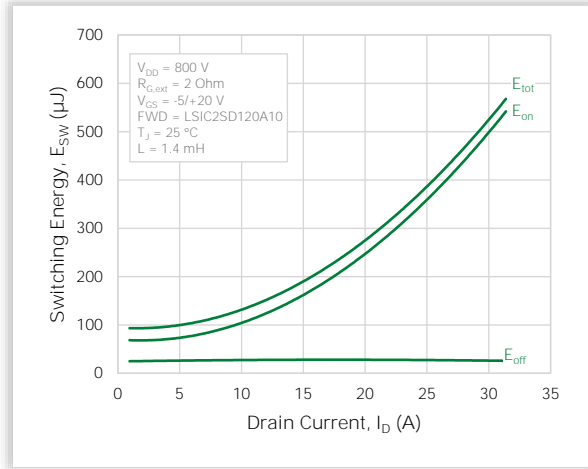


Figure 20. Typical Switching Energy vs. External Gate Resistance

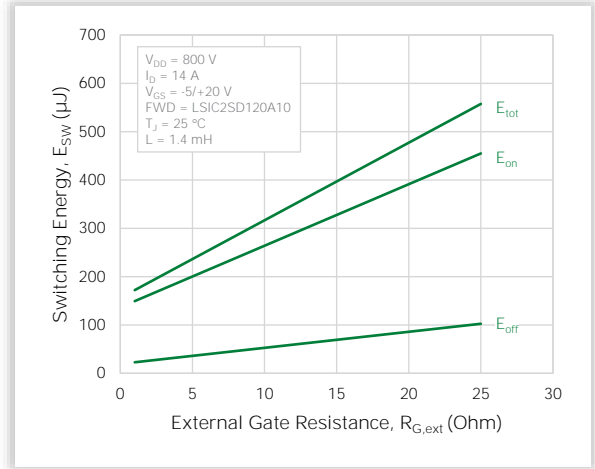
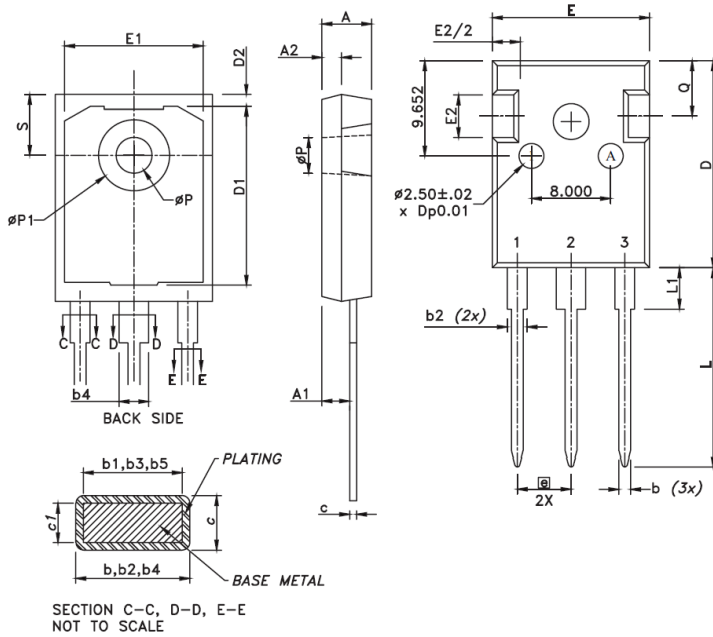


Figure 21. V\_GS Waveform Definition

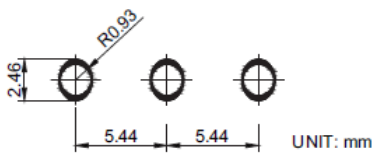




### 6. Package Dimensions



Recommended Hole Pattern Layout:

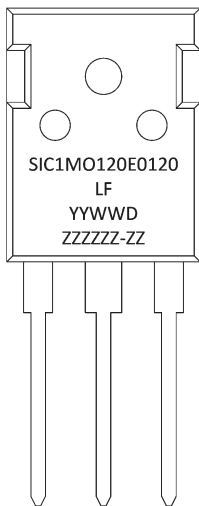


Notes:

1. Dimensions are in millimeters
2. Dimensions D & E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extreme of the plastic body.
3. øP to have a maximum draft angle of 1.7° to the top of the part with a maximum hole diameter of 3.912 mm.

| Symbol | Millimeters |     |        |
|--------|-------------|-----|--------|
|        | Min         | Nom | Max    |
| A      | 4.699       | -   | 5.309  |
| A1     | 2.210       | -   | 2.591  |
| A2     | 1.499       | -   | 2.489  |
| b      | 0.990       | -   | 1.400  |
| b2     | 1.650       | -   | 2.390  |
| b4     | 2.590       | -   | 3.430  |
| c      | 0.380       | -   | 0.890  |
| D      | 20.800      | -   | 21.463 |
| D1     | 13.081      | -   | -      |
| D2     | 0.508       | -   | 1.350  |
| e      | 5.440 BSC   |     |        |
| E      | 15.494      | -   | 16.256 |
| E1     | 13.060      | -   | 14.150 |
| E2     | 3.429       | -   | 5.486  |
| L      | 19.810      | -   | 20.570 |
| L1     | 3.810       | -   | 4.496  |
| øP     | 3.550       | -   | 3.660  |
| øP1    | 7.060       | -   | 7.390  |
| Q      | 5.385       | -   | 6.200  |
| S      | 6.050       | -   | 6.300  |

### 7. Part Numbering and Marking



- SiC = SiC
- 1 = Gen 1
- MO = MOSFET
- 120 = Voltage Rating (1200 V)
- E = TO-247-3L
- 0120 =  $R_{DS(ON)}$  (120 mOhm)
- YY = Year
- WW = Week
- D = Special Code
- ZZZZZZ-ZZ = Lot Number

### 8. Packing Options

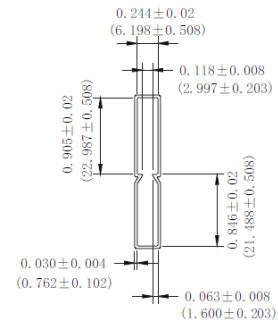
| Part Number     | Marking        | Packing Mode  | M.O.Q. |
|-----------------|----------------|---------------|--------|
| LSIC1MO120E0120 | SIC1MO120E0120 | Tube (30 pcs) | 450    |

9. Packing Specifications



**NOTE:**

- 1. All pin plug holes are considered critical dimension
- 2. Tolerance is to be ±0.010 unless otherwise specified
- 3. Dimension are in inch (and millimeters).



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